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Docket No.: M4065.0361/P361
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Letters Patent of:
Whonchee Lee, et al.

Patent No.: 6,867,448 B1

Issued: March 15, 2005

For: ELECTRO-MECHANICALLY POLISHED
STRUCTURE

Certificate
AUG 24 2005
of Correction

REQUEST FOR CERTIFICATE OF CORRECTION
PURSUANT TO 37 CFR 1.322 & 1.323

Commissioner for Patents
MS: Post Issue
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Upon reviewing the above-identified patent, Patentees noted omissions and typographical errors which should be corrected.

In the References Cited "U.S. Patent Documents":

The following U.S. Patents have been omitted and should be listed. They appear on the IDS we filed on February 6, 2004. The Examiner reviewed and acknowledged review of the references by initialing the IDS on May 20, 2004.

6,103,096 08/15/2000 Datta, et al.

6,280,581 08/28/2001 Cheng

08/19/2005 SSITHIB1 00000131 6867448
01 FC:1811

100.00 Op

DSMDB.1967602.1

AUG 24 2005

6,379,223

04/30/2002

Sun, et al.

In the References Cited "Other Publications":

The following reference has errors in the citation which should be corrected:

On page 2: Huang, C.S. et al., "A Novel UV Baking Process to Improve DUV Photoresist Hardness," pp. 135-138, Proceedings of Technical Papers: June 8-10, 1999, Taipei, Taiwan, Institute of Electrical and Electronics Engineers, Inc., September 1999. "pp. 135-138, Proceedings of" should read --pp. 135-138; Proceedings of the 1999 International Symposium on VLSI Technology, Systems and Applications: Proceedings of--.

In the Specification:

Column. 1, line 24, "wells" should read --well--;

Column. 3, line 61, "alloy" should read --alloys--.

The grammatical errors in the specification, Col. 1, line 24 and Col. 3, line 61, were found in the application as-filed by the Patentees. The grammatical errors now sought to be corrected are inadvertent typographical errors, the correction of which does not involve new matter or require reexamination. Please charge our Credit Card in the amount of \$100.00 covering the fee set forth in 37 CFR 1.20(a). Credit Card Payment Form SB-2038, with a signature from an authorized cardholder, is enclosed.

The omissions and typographical errors in the References Cited portions were not in the application as-filed or amended by the Patentees. The errors sought to be corrected are inadvertent omissions and typographical errors on the part of the USPTO, the correction of which does not involve new matter or require reexamination.

Transmitted herewith is a proposed Certificate of Correction effecting such amendment. Patentees respectfully solicit the granting of the requested Certificate of Correction.

The Commissioner is also hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 04-1073, under Order No. M4065.0361/P361. A duplicate copy of this paper is enclosed.

Dated: August 18, 2005

Respectfully submitted,

By 

Thomas J. D'Amico

Registration No.: 28,371

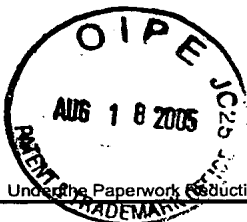
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Attorney for Applicants



FEE TRANSMITTAL For FY 2005 <input type="checkbox"/> Applicant claims small entity status. See 37 CFR 1.27		Complete if Known		
		Application Number	Patent#: 6,867,448	
		Filing Date	Issued: March 15, 2005	
		First Named Inventor	Whonchee Lee	
		Examiner Name	J. H. Nguyen	
TOTAL AMOUNT OF PAYMENT (\$)		100.00	Art Unit	2815
			Attorney Docket No.	M4065.0361/P361

METHOD OF PAYMENT (check all that apply)	
<input type="checkbox"/> Check	<input checked="" type="checkbox"/> Credit Card
<input type="checkbox"/> Money Order	<input type="checkbox"/> None
<input type="checkbox"/> Other (please identify):	
<input checked="" type="checkbox"/> Deposit Account Deposit Account Number: <u>04-1073</u> Deposit Account Name: <u>Dickstein Shapiro Morin & Oshinsky LLP</u>	
For the above-identified deposit account, the Director is hereby authorized to: (check all that apply)	
<input type="checkbox"/> Charge fee(s) indicated below	<input type="checkbox"/> Charge fee(s) indicated below, except for the filing fee
<input type="checkbox"/> Charge any additional fee(s) or underpayment of fee(s) under 37 CFR 1.16 and 1.17	<input checked="" type="checkbox"/> Credit any overpayments

FEE CALCULATION							
1. BASIC FILING, SEARCH, AND EXAMINATION FEES							
	FILING FEES		SEARCH FEES		EXAMINATION FEES		
		Small Entity		Small Entity		Small Entity	
Application Type	Fee (\$)	Fee (\$)	Fee (\$)	Fee (\$)	Fee (\$)	Fee (\$)	Fees Paid (\$)
Utility	300	150	500	250	200	100	
Design	200	100	100	50	130	65	
Plant	200	100	300	150	160	80	
Reissue	300	150	500	250	600	300	
Provisional	200	100	0	0	0	0	
2. EXCESS CLAIM FEES							
						Small Entity	
						Fee (\$)	Fee (\$)
Each claim over 20 (including Reissues)						50	25
Each independent claim over 3 (including Reissues)						200	100
Multiple dependent claims						360	180
Total Claims		Extra Claims	Fee (\$)	Fee Paid (\$)	Multiple Dependent Claims		
_____ - = _____		x _____	= _____		Fee (\$) Fee Paid (\$)		
Indep. Claims		Extra Claims	Fee (\$)	Fee Paid (\$)			
_____ - = _____		x _____	= _____				
3. APPLICATION SIZE FEE							
If the specification and drawings exceed 100 sheets of paper (excluding electronically filed sequence or computer listings under 37 CFR 1.52(e)), the application size fee due is \$250 (\$125 for small entity) for each additional 50 sheets or fraction thereof. See 35 U.S.C. 41(a)(1)(G) and 37 CFR 1.16(s).							
Total Sheets	Extra Sheets	Number of each additional 50 or fraction thereof			Fee (\$)	Fee Paid (\$)	
_____ - 100 = _____	/50	_____ (round up to a whole number) x _____			= _____		
4. OTHER FEE(S)							
Non-English Specification, \$130 fee (no small entity discount)							
Other (e.g., late filing surcharge): <u>1811 Certificate of correction</u>							100.00

SUBMITTED BY			
Signature		Registration No. (Attorney/Agent)	28,371
Name (Print/Type)	Thomas J. D'Amico	Telephone	(202) 828-2232
		Date	August 18, 2005

AUG 24 2005

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.
(Also Form PTO-1050)

UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO. : 6,867,448 B1

Page 1 of 1

DATED : March 15, 2005

INVENTORS : Whonchee Lee, et al.

It is certified that omissions and typographical errors appear in the above-identified patent and that said Letters Patent is hereby corrected by the information shown below:

In the References Cited "U.S. Patent Documents":

The following U.S. Patents have been omitted and should be added:

6,103,096	08/15/2000	Datta, et al.
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